INNOLUX DISPLAY CORPORATION LCD MODULE SPECIFICATION

Customer:

Model Name: Spec. No.: Date: Version: <u>CT028TN03 (Puma-T1)</u> <u>C028-03-TT-01</u> <u>2008/01/02</u> 1.0

Preliminary Specification
 Final Specification

For Customer's Acceptance

Approved by	Comment
	-0

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Record of Revision

Version	Revise Date	Page	Content
1.0	2008/01/02	All	Initial release
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1. General Specifications

1.1 Description

The CT028TN03 is a color active matrix Thin Film Transistor (TFT) Liquid Crystal Display (LCD) that uses amorphous silicon (a-Si) TFT as a switching device. This model is composed of a single 2.8 inches transmissive type main TFT-LCD panel and a resistive touch screen display. The resolution of the panel is 240x320 pixels and can display up to 65K/262K color.

1.2 Features

- -TM type for main TFT-LCD panel
- -Resistive type touch panel
- -One backlight with 4 white LEDs
- -80-system 18/16/8-bit parallel bus
- -Full, Still, Partial & Standby modes are available

1.3 Application

-Display terminals for cellular phone

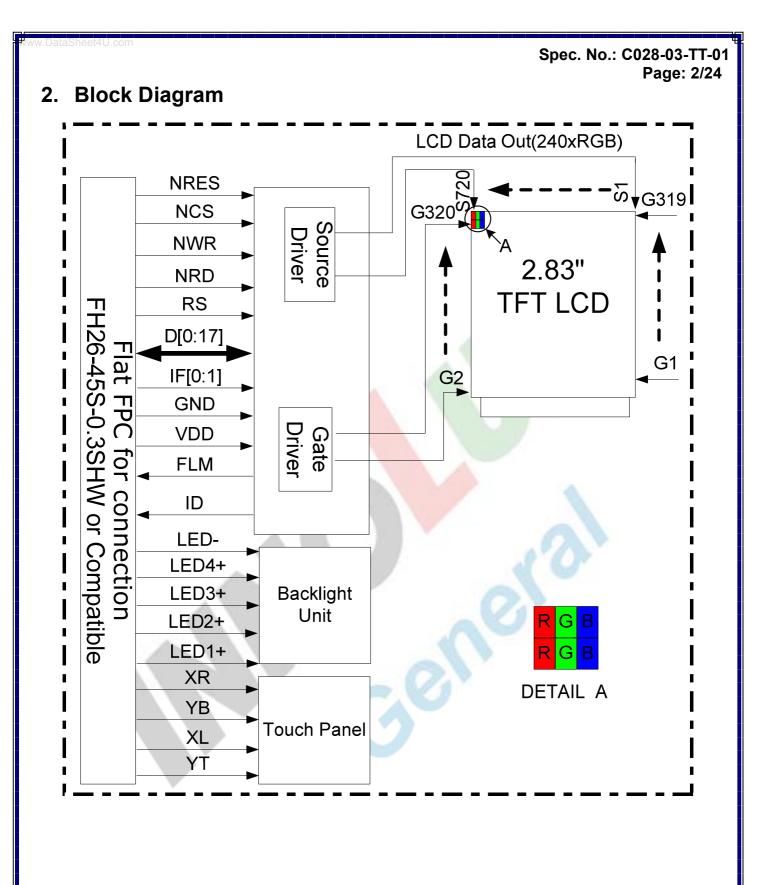
1.4 General Specification

No.	ltem	Spec ification	Unit	Remark
1	LCD Size	2.83	inch	-
2	Panel Type	a-Si TFT active matrix	-	-
3	Touch Panel Type	4-wire Analog Resistive	-	-
4	Resolution	240 x RGB x 320	pixel	-
5	Display Mode	Normally white, Transmissive	9	-
6	Display Number of Colors	65K/262K	- (-
7	Viewing Direction	12 o'clock	_	Note 1
8	Contrast Ratio	500	-	-
9	Luminance	250	cd/m ²	Note 2
10	Module Size	50.20(W) x 69.30(L) x 3.65 (T)	mm	Note 1
11	Panel Active Area	43.20(W) x 57.60(L)	mm	Note 1
12	Touch Panel Active Area	44.20(W) x 62.50(L)	mm	Note 1
13	Touch Panel View Area	44.80(W) x 63.10(L)	mm	Note 1
14	Pixel Pitch	0.180(W) x 0.180(L)	mm	-
15	Weight	TBD	9	-
16	Driver IC	HX8347	-	-
17	Driver IC RAM Size	240 x 18 x 320	bit	-
18	Light Source	4 white LEDs in Parallel	-	-
19	Interface	80-system 18/16/8-bit parallel bus	-	-
20	Operating Temperature	-20~70	°C	-
21	Storage Temperature	-30~80	°C	-

Note 1: Please refer to the mechanical drawing.

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Note 2: Luminance is measured with touch panel attached.



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3. Pin Assignments

Pin No.	Symbol	I/O	Function	Remark
1	FLM	0	Connect to TE(Tearing Effect) Pin	-
2	GND	Р	Ground	-
3	YB	-	Touch panel signal	-
4	XR	-	Touch panel signal	-
5	ΥT	-	Touch panel signal	-
6	XL	-	Touch panel signal	-
7	GND	Р	Ground	-
8	IF0	I	Interface select signal	Note 2
9	IF1	I	Interface select signal	Note 2
10	VDD	Р	Analog/Log <mark>ic supp</mark> ly voltage	Note 1
11	VDD	Р	Analog/Logic supply voltage	Note 1
12	VDD	Р	Analog/Logic sup <mark>ply voltage</mark>	Note 1
13	NC	-	Dummy Pin	-
14	D17	I/O	Data bus (Bit 17)	-
15	D16	I/O	Data bus (Bit 16)	-
16	D15	I/O	Data bus (Bit 15)	-
17	D14	I/O	Data bus (Bit 14)	-
18	D13	I/O	Data bus (Bit 13)	-
19	D12	I/O	Data bus (Bit 12)	-
20	D11	I/O	Data bus (Bit 11)	-
21	D10	I/O	Data bus (Bit 10)	-
22	D9	I/O	Data bus (Bit 9)	-
23	D8	I/O	Data bus (Bit 8)	-
24	D7	I/O	Data bus (Bit 7)	-
25	D6	I/O	Data bus (Bit 6)	-
26	D5	I/O	Data bus (Bit 5)	-
27	D4	I/O	Data bus (Bit 4)	-
28	D3	I/O	Data bus (Bit 3)	-
29	D2	I/O	Data bus (Bit 2)	-

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30	D1	I/O	Data bus (Bit 1)	-
31	D0	I/O	Data bus (Bit 0)	-
32	NRES	I	Reset signal (Low: active)	-
33	NRD	I	Read signal (Low: active)	-
34	NWR	I	Write signal (Low: active)	-
35	RS	I	Register select signal	-
36	NCS	I	Chip select signal (Low: active)	-
37	GND	Р	Ground	-
38	LED1+	-	LED anode	-
39	LED2+	-	LED anode	-
40	LED3+	-	LED anode	-
41	LED4+	-	LED anode	-
42	NC	-	Dummy Pin	-
43	NC	-	Dummy Pin	-
44	LED-	-	LED cathode	-
45	ID	0	Connect to VDD by a 120KΩ resister	-

Note 1: There is only one power VDD input to combine digital power and analog power.

Note 2: Interface Selection

IF0	IF1	Bus Width	Bit Number in a pixel	Data Bus
0	0	16-bit parallel	16-bit (65K)	D15~D0
0	1	18-bit parallel	18-bit (262K)	D17~D0
1	1	8-bit parallel	18-bit (262K)	D7~D0

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4. Electrical Specifications

4.1 Absolute Maximum Rating

						(T _a =+25℃)
	Symbol Values			Unit	Remark	
Item		c j	Min.	Max.		
TFT Module	Analog/Logic Supply Voltage	VDD	-0.3	+4.6	V	Note 1
Backlight Llpit	Current	Ι _Β	-	120	mA	Note 2
Backlight Unit	Power Consumption	P_{BL}	-	480	mW	Note 2

Note1: Permanent damage to the device may occur if maximum values are exceeded or reverse voltage is applied.

Note2: Without LED driver IC, please refer to 4.3.

4.2 Typical Operation Conditions

4.2.1 DC Characteristics

ltem	Symbol		Values	Unit	$(I_a=+25C)$	
item	Symbol	Min.	Тур.	Max.		Remark
Analog/ Logic Supply Voltage	VDD	2.7	2.8	3.0	V	2
Input High Voltage	V _{IH}	0.8 VDD	-	VDD	V	
Input Low Voltage	V _{IL}	0	-	0.2VDD	V	Note
Output Low Voltage	V _{OL}	0	-	0.2VDD	V	NOLE
Output High Voltage	V _{OH}	0.8 VDD	-	VDD	V	
Frame Frequency	f _{FRAME}	-	80	_	Hz	

Note: To prevent IC latch up or DC operation in LCD panel, the power on/off sequence should follow the driver IC specification.

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4.2.2 Current Consumption

	ltem	Symbol	Val	ues	Unit	Remark		
		Symbol	Тур.	Max.	Jint			
	MCU Interface (80-system 1	8/16/8-bit para	allel bus)					
	Still Mode	VDD	TBD	TBD	mA	Note1		
	Standby Mode	VDD	TBD	TBD	uA	Note1, Note2		
Note	1: Test Condition							
Тур:	VDD=2.8V		Max:	VDD=3.0	v 🗸			
	Display Pattern: 8 Color E	Bar		Display P	attern:	All Pixel Black		
	Frame Rate=80Hz at Line	e Inversion		Frame Rate=80Hz at Line Inversion				
	Operating Temperature: 2	25° ℃		Operating Temperature: 25°C				
	Typ. current che	ck pattern:		Max. current check pattern:				
	8-Color E	Bar				Black		

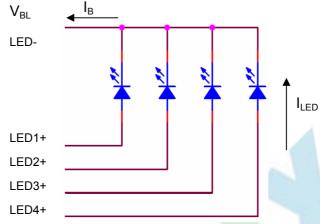
Note2: In the standby mode, all the internal display operations are suspended including the internal R-C oscillator.

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4.3 Backlight Unit

The backlight system is an edge lighting type with 4 white LEDs.



(T_a=+25°℃)

ltem	Symbol	Values			Unit	Remark	
		Min.	Тур.	Max.			
Current	I _B	-	80	-	mA	Note 1	
Power Consumption	P _{BL}	-	270	0	mW	Note 2	

Note1: 4 LEDs are connected in parallel; each LED's current consumption is 20mA.

Note2: Where I_B = 80mA, P_{BL} = $I_B x V_{BL}$, V_{BL} is backlight forward voltage.

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4.4 Instruction Setting Flow

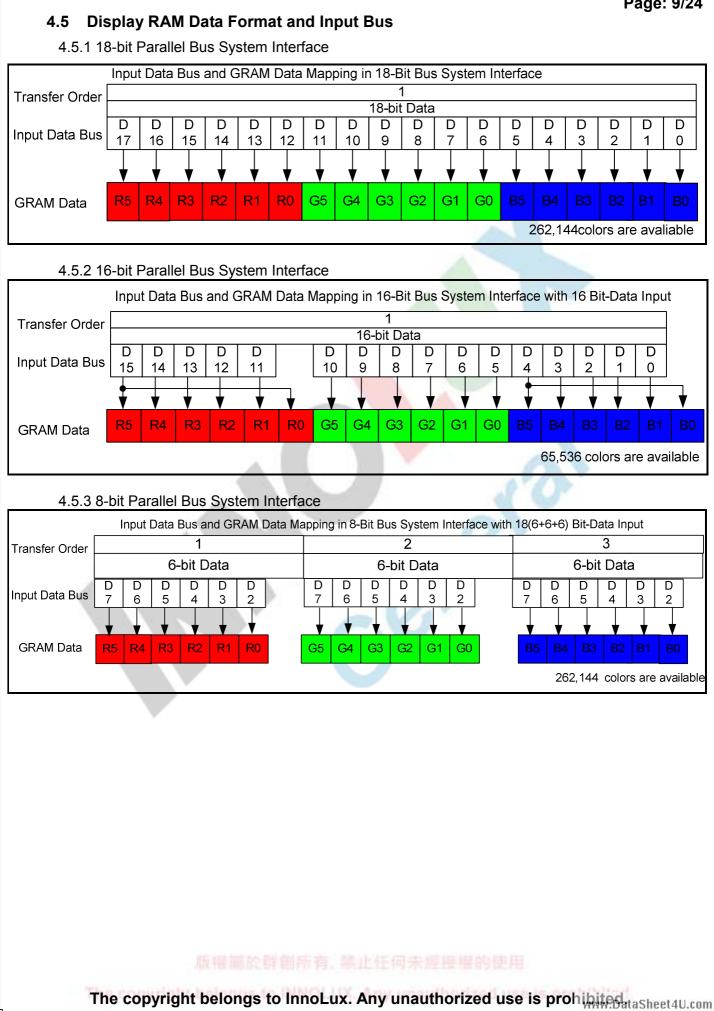
- 4.4.1 Initial Setting Sequence TBD
- 4.4.2. Standby In/Out Sequence TBD

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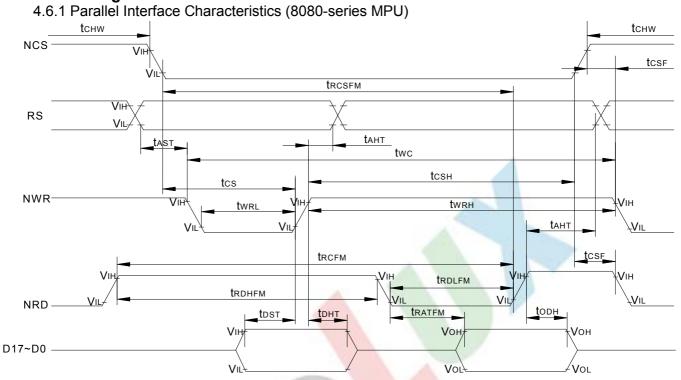
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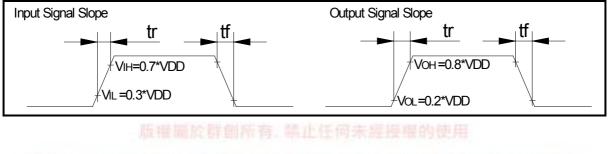
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4.6 Timing Characteristic



					(VE	DD=2.7 to 3.0V, Ta=25℃)	
Signal	Symbol	Parameter	Min.	Max	Unit	Description	
RS	t _{AST}	Address setup time	10	-	ns		
RO	t _{AHT}	Address hold time (Write/Read)		-	115		
	t _{CHW}	Chip select "H" pulse width	0	-	1		
	t _{cs}	Chip select setup time (Write)	35	-	110		
NCS	t _{RCSFM}	Chip select setup time	180		ns	-	
	t _{CSF}			-			
	t _{сsн}	Chip select hold time	10	-			
	t _{wc}	Write cycle	100				
NWR	t _{wRH}	Control pulse "H" duration	15	- N	ns	-	
	t _{WRL}	Control pulse "L" duration		-			
	t _{RCFM}	Read cycle	250	-			
NRD	t _{RDHFM}	Control pulse "H" duration	15	-	ns	When read from GRAM	
	t _{RDLFM}	Control pulse "L" duration	180	-			
	t _{DST}	Data setup time	10	-			
D0 to	t _{DHT}	Data hold time		-	20	For maximum C _L =30pF	
D17	t _{RATFM}	Read access time	-	ne		For minimum C _L =8pF	
	t _{ODH}	Output disable time	20	80			

Note: The input signal rise time and fall time (tr, tf) is specified at 15ns or less. Logic high and low levels are specified as 30% and 70% of VDD for input signals.



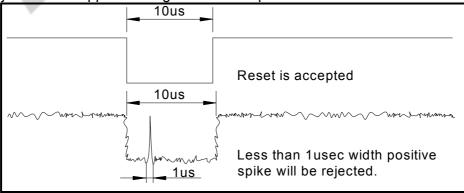
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4.6.2 Reset Input Timing 0.8*VDD		
	Shorter than 5us	
NRES		r
Internal Status	Normal Operation Resetting	Initial Condition (Default for H/W reset)

Symbol	Parameter	Related Pins	Min.	Тур.	Max.	Note	Unit
tRESW	Reset low pulse width ⁽¹⁾	NRES	10	-	-		μs
tREST	Reset complete time ⁽²⁾	-	-		5	When reset applied during STB mode	ms
			-	-	120	When reset applied during STB mode	ms
tPRES	Reset goes high level after Power on time	NRES &VDD	1			Reset goes high level after Power on	ms

Note: (1) Spike due to an electrostatic discharge on NRES line does not cause irregular system reset according to the table below.

NRES Pulse	Action					
Shorter than 5µs	Reset Rejected					
Longer than 10µs	Reset					
Between 5µs and 10µs	Reset Start					

- (2) During the resetting period, the display will be blanked (The display is entering blanking sequence, which maximum time is 120 ms, when Reset Starts in STB Out-mode, the display remains the blank state in STB-mode) and then return to Default condition for H/W reset.
- (3) During Reset Complete Time, ID2 and VCOMOF value in OTP will be latched to internal register during this period. This loading is done every time when there is H/W reset complete time (tREST) within 5ms after a rising edge of NRES.
- (4) Spike Rejection also applies during a valid reset pulse as shown below:



(5) It is necessary to wait 5msec after releasing NRES before sending commands. Also STB Out command cannot be sent for 120msec.

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5 Touch Panel Specifications

5.1 **Electrical Characteristics**

ltem		Value		Unit	Remark	
item	Min.	Тур.	Max.	Ont		
Linearity	-1.5	-	1.5	%	Note 3	
Terminal	180	-	560	Ω	Х	
Resistance	270	-	760	Ω	Y	
Insulation resistance	25	-	-	MΩ	DC 25V	
Operating Voltage	-	5	-	V	DC	

5.2 **Optical Characteristics**

Item		Value		Unit	Remark	
i i i i i i i i i i i i i i i i i i i	Min.	Тур.	Max.	Onit	Kennark	
Response Time	- 9		10	ms	100kΩ pull-up	
Light Transparency	80		-	%	-	

5.3 Mechanical Characteristics

5.3 Mechanical Characteristics							
ltem -		Value	Unit	Remark			
item	Min.	Тур.	Max.	Onn	Rellark		
Active Force			80	gf	Note 1		
Surface Hardness	3	-	2	Н	-		
Pen Sliding Durability	100,000	2		time	Note 2, 4		
Hitting Durability	1,000,000		-	time	Note 2, 5		

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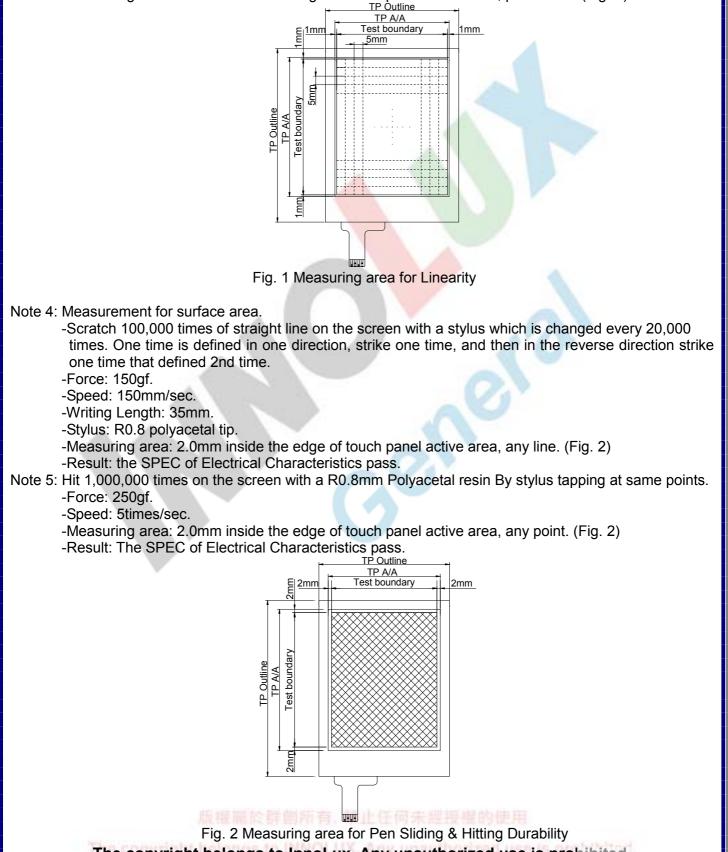
- Note 1: Do not operate it with a stylus other than a polyacetal pen (tip R0.8mm or less) or a finger, especially those with hard or sharp tips such as a ball point pen or a mechanical pencil.
- Note 2: Test Condition:

End shape: R0.8mm and R8.0mm,

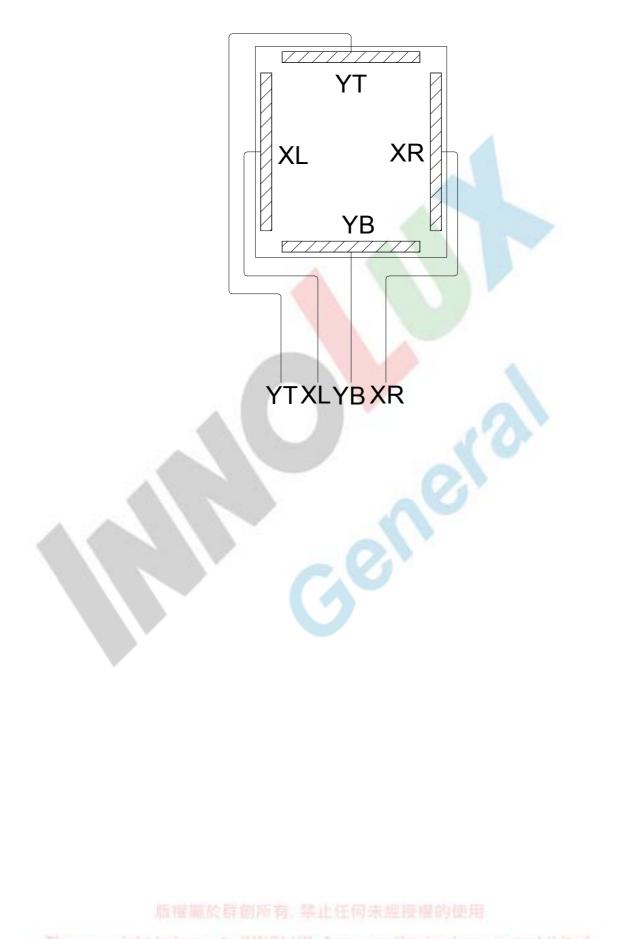
Resistance between X and Y axis must be equal or lower than $2K\Omega$, the test voltage =DC5V. Note 3: Measurement For Linearity. (After environment and life test)

-Load: 150g with End shape R0.8 mm Polyacetal resin.

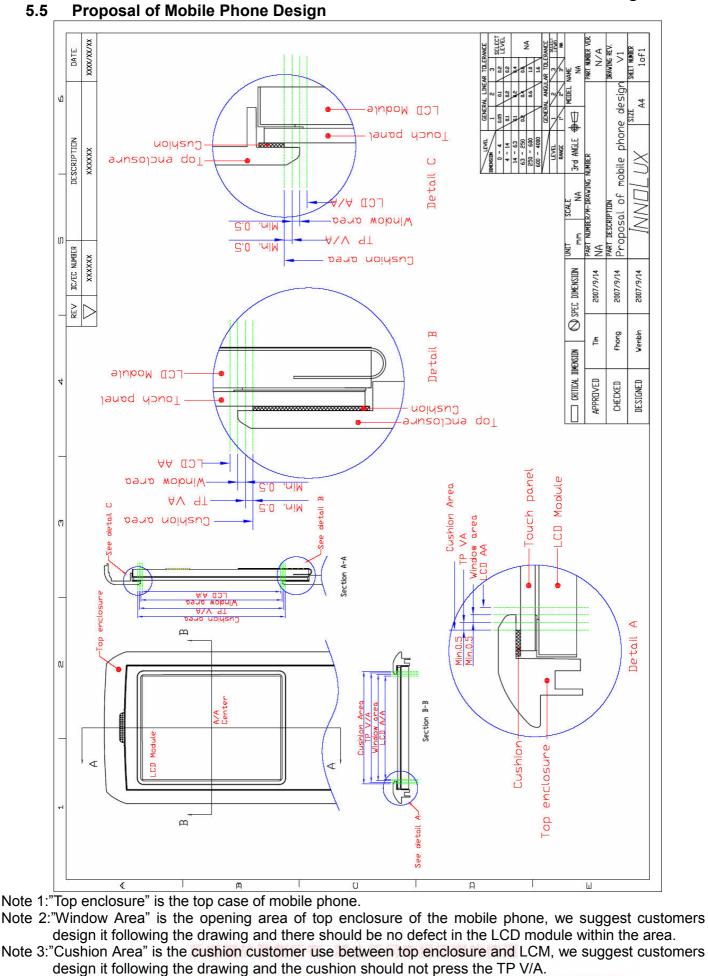
-Measuring area: 1.0mm inside the edge of touch panel active area, pitch 5mm. (Fig. 1)



5.4 Touch Panel Circuit Block



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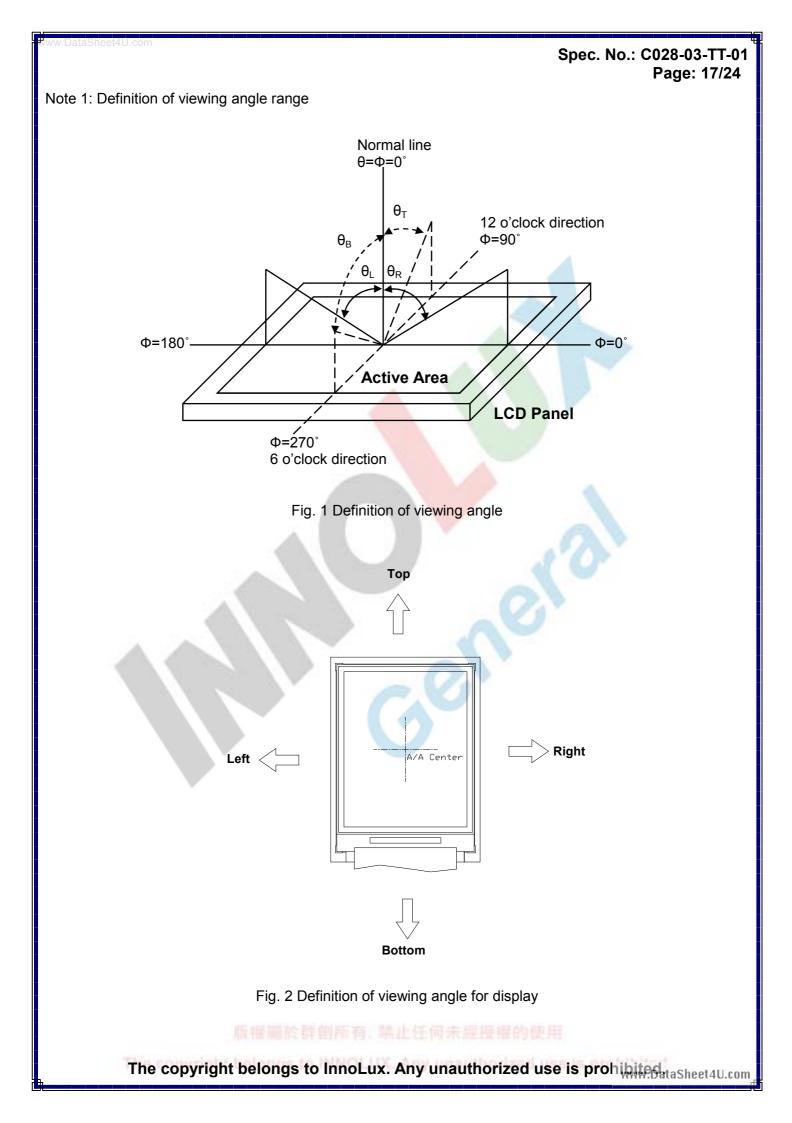
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6 Optical Specifications

(Ta=+25°C, VDD=+2.8V, I_B=80mA)

ltom		Symbol	Condition		Values	- 0)	<u>D=+2.0v,</u>	Remark	
ltem	nem		Condition	Min.	Тур.	Max.	Unit		
	Left	θ∟	CR≧10	-	65	-		Note 1,2	
Viewing Angle	Right	θ_{R}		-	65	-	degree		
Range	Тор	θτ	UR≦ IU	-	65	-			
5	Bottom	θΒ		-	55				
Response	Time	T_{on} + T_{off}	Normal θ=Φ=0°	-	25	2	ms	Note 2,3	
Contrast I	Ratio	CR	Normal θ=Φ=0°	350	500		1	Note 2,4	
Luminar	nce	L	Normal θ=Φ=0°	-	250	-	cd/m ²	Note 2,5	
	White	W _x		-	0.28	-	_	Note 2,6	
	VVIILE	Wy	Normal $\theta = \Phi = 0^{\circ}$ $\begin{array}{c cccc} - & 0.29 & - \\ - & 0.59 & - \\ - & 0.34 & - \\ - & 0.34 & - \\ - & 0.58 & - \\ - & 0.14 & - \end{array}$	2-	0.29	-			
	Red	R _x		-	0.59	-			
Color Chromaticity	ricu	Ry			0.34	-			
(CIE1931)	Green	G _x		-	0.34	-			
	Oreen	Gy							
	Blue	B _x			0.14	-			
	Dide	By		- /	0.06				
Color Ga	Color Gamut		CIE1931	- 1	55	1	%	-	
Luminance Uniformity		UL	Normal θ=Φ=0°	75	80	G.	%	Note 2,7	
Flicker		-	-		No Visible	е	-	Note 8	
Crossta	alk		-	20	No Visible	e	-	Note 9	

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Note 2: Definition of optical measurement system

The optical characteristics should be measured in a dark room with ambient temperature T_a =+25°C. The optical properties are measured at the center point of the LCD screen after 5 minutes operation. (Equipment: Photo detector TOPCON BM-5A or BM-7 /Field of view: 1° /Height: 500mm.)

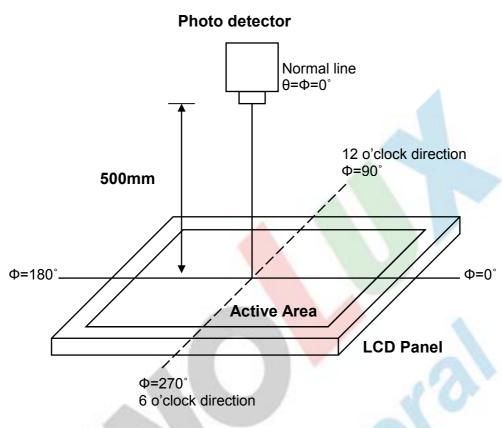
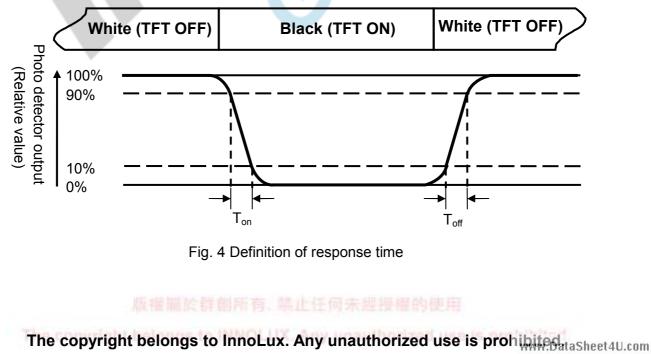
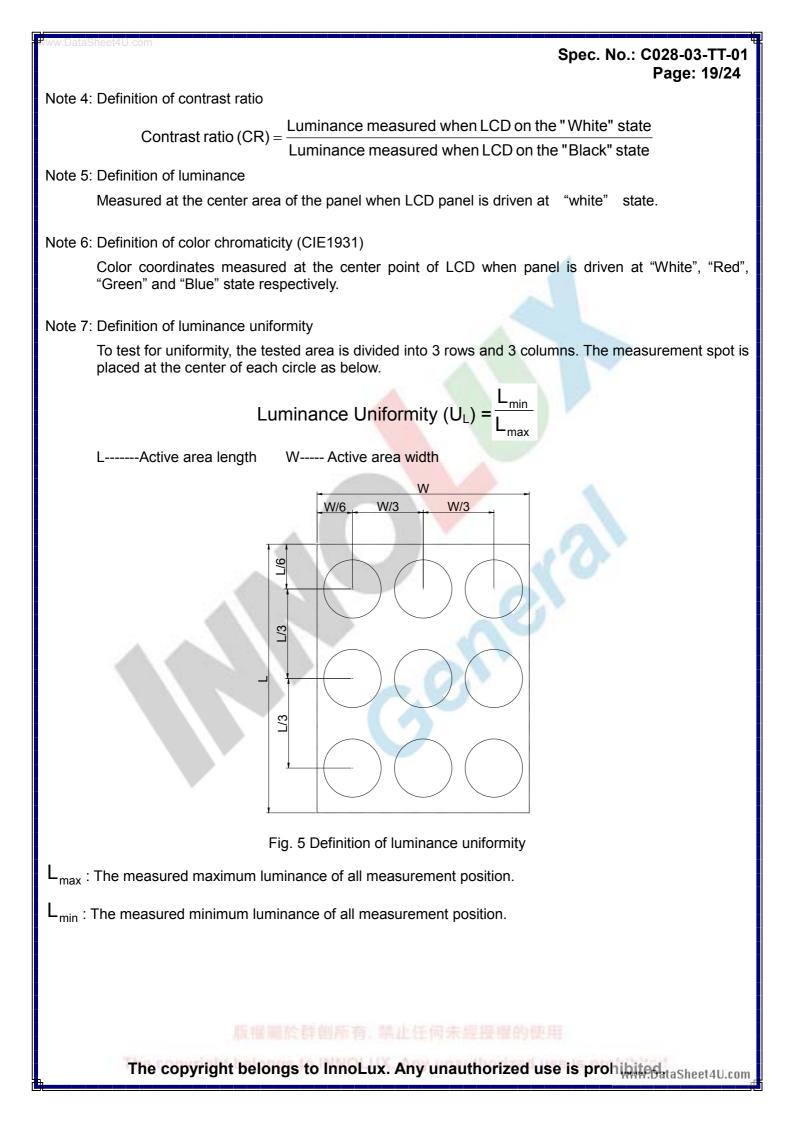


Fig. 3 Optical measurement system setup

Note 3: Definition of response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (T_{on}) is the time between photo detector output intensity changed from 90% to 10%, and fall time (T_{off}) is the time between photo detector output intensity changed from 10% to 90%.

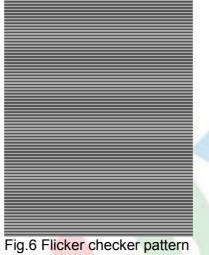




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Note 8: Definition of Flicker

Flicker is the pattern usually used to describe the visual sensation produced by a rapidly varying light intensity. There should be no visible flicker in normal direction of the display when the following figure is loaded.



Note9: Definition of crosstalk

There should be no visible in normal direction of the display when the following figures are loaded.

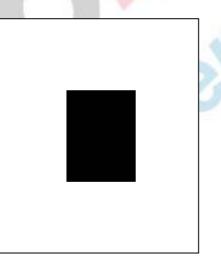


Fig.7 Crosstalk checker pattern

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7 Reliability Test Items

Test Items	Test Conditions	Remark
High Temperature Storage	+80℃±3℃ for 240 hours	-
Low Temperature Storage	$-30^{\circ}C\pm 3^{\circ}C$ for 240 hours	-
High Temperature Operation	+70°C±3°C for 240 hours	-
Low Temperature Operation	-20 $^{\circ}$ C ±3 $^{\circ}$ C for 240 hours	-
High Temperature and Humidity Operation	+60℃±3℃, 90%±3%RH max. for 240 hours	-
Thermal Shock	-30° C/0.5h ~ +80°C/0.5h for a total 100 cycles, Start with cold temp and end with high temp	-
Vibration Test	Frequency range:10~55Hz Stoke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X. Y. Z. (6 hours for total)	-
Mechanical Shock	100G 6ms,±X, ±Y, ±Z <mark>3 times fo</mark> r each direction	-
Package Vibration Test	Random Vibration : 0.015G ² /Hz from 5-200Hz, -6dB/Octave from 200-500Hz 1 hour for each direction of X. Y. Z. (3 hours for total)	_
Package Drop Test	Height :72cm(Weight≦10kg); 60cm(Weight>10kg) 1 corner, 3 edges, 6 surfaces	-
Electro Static Discharge	± 2KV, Human Body Mode, 100pF/1500Ω	-

Note1: During the display practical test under normal operation condition, there shall be not change or effect to the display function.

Note2: Before function check, the test sample requires 2 hours storage at room temperature.

Before test the function of TP, the sample must be placed in room temperature for 24hrs after RA test.

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8 Handling Precautions

8.1. Safety

8.1.1 The liquid crystal in the LCD is poisonous. DO NOT put it in your mouth. If the liquid crystal touches your skin or clothes, wash it off immediately using soap and water.

8.2. Handling

- 8.2.1 The LCD and touch panel is made of plate glass. **DO NOT** subject the panel to mechanical shock or to excessive force on its surface.
- 8.2.2 Do not handle the product by holding the flexible pattern portion in order to assure the reliability
- 8.2.3 Transparency is an important factor for the touch panel. Please wear clear finger sacks, gloves and mask to protect the touch panel from finger print or stain and also hold the portion outside the view area when handling the touch panel.
- 8.2.4 Provide a space so that the panel does not come into contact with other components.
- 8.2.5 To protect the product from external force, put a covering lens (acrylic board or similar board) and keep an appropriate gap between them.
- 8.2.6 Transparent electrodes may be disconnected if the panel is used under environmental conditions where dew condensation occurs.
- 8.2.7 Property of semiconductor devices may be affected when they are exposed to light, possibly resulting in IC malfunctions.
- 8.2.8 To prevent such IC malfunctions, your design and mounting layout shall be done in the way that the IC is not exposed to light in actual use.

8.3. Static Electricity

- 8.3.1 Ground soldering iron tips, tools and testers when they are in operation.
- 8.3.2 Ground your body when handling the products.
- 8.3.3 Power on the LCD module BEFORE applying the voltage to the input terminals.
- 8.3.4 DO NOT apply voltage which exceeds the absolute maximum rating.
- 8.3.5 Store the products in an anti-electrostatic bag or container.

8.4. Storage

- 8.4.1 Store the products in a dark place at $+25^{\circ}C \pm 10^{\circ}C$ with low humidity (65%RH or less).
- 8.4.2 DO NOT store the products in an atmosphere containing organic solvents or corrosive gas.

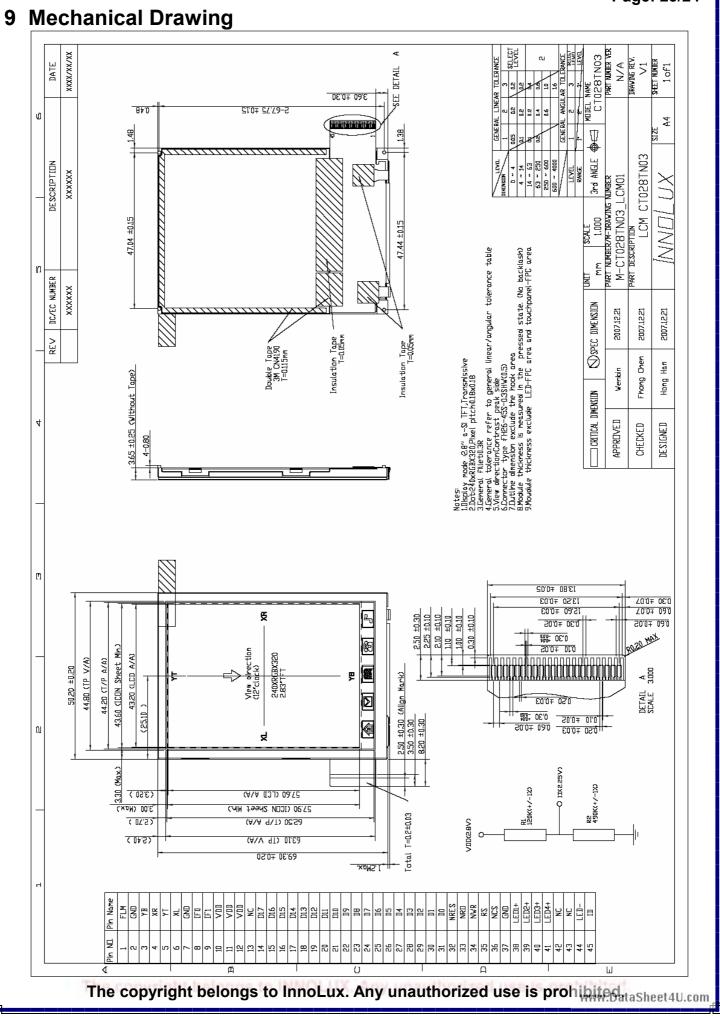
8.5. Cleaning

- 8.5.1 **DO NOT** wipe the touch panel with dry cloth, as it may cause scratch.
- 8.5.2 Wipe off the stain on the product by using soft cloth moistened with ethanol. **DO Not** allow ethanol to get in between the upper film and the bottom glass. It may cause peeling issue or defective operation. **Do not** use any organic solvent or detergent other than ethanol.

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10. Package Drawing

10.1. Packing Material Per Carton

TBD

10.2. Packing Specification and Quantity TBD

10.3. Illustration

TBD

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